

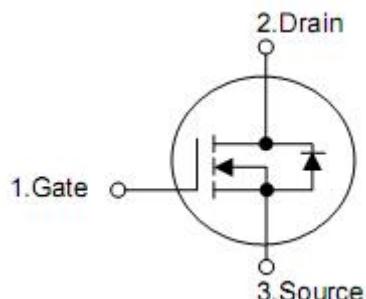
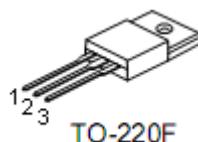
## 1. Description

This Power MOSFET is produced using KIA semi's advanced planar stripe DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.

## 2. Features

- $R_{DS(on)}=1.15\Omega$  @  $V_{GS}=10V$
- Low gate charge ( typical 22nC)
- High ruggedness
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

## 3. Pin configuration



Pin	Function
1	Gate
2	Drain
3	Source
4	Drain

## 4. Absolute maximum ratings

( $T_c = 25^\circ\text{C}$ , unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-source voltage	$V_{DSS}$	600	V
Gate-source voltage	$V_{GSS}$	$\pm 30$	V
Drain current continuous	$I_D$	7.0*	A
		4.2*	A
Drain current pulsed (note1)	$I_{DM}$	28*	A
Avalanche energy	Repetitive (note1)	$E_{AR}$	mJ
	Single pulse (note2)	$E_{AS}$	mJ
Peak diode recovery dv/dt (note3)	dv/dt	4.5	V/ns
Total power dissipation	$P_D$	39	W
		0.31	W/ $^\circ\text{C}$
Operating and storage temperature range	$T_J, T_{STG}$	-55~+150	$^\circ\text{C}$
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	$T_L$	300	$^\circ\text{C}$

\* Drain current limited by maximum junction temperature

## 5. Thermal characteristics

Parameter	Symbol	Rating	Unit
Thermal resistance, Junction-ambient	$R_{thJA}$	62.5	$^\circ\text{C/W}$
Thermal resistance, case-to-sink typ.	$R_{thCS}$	-	$^\circ\text{C/W}$
Thermal resistance, Junction-case	$R_{thJC}$	3.2	$^\circ\text{C/W}$

## 6. Electrical characteristics

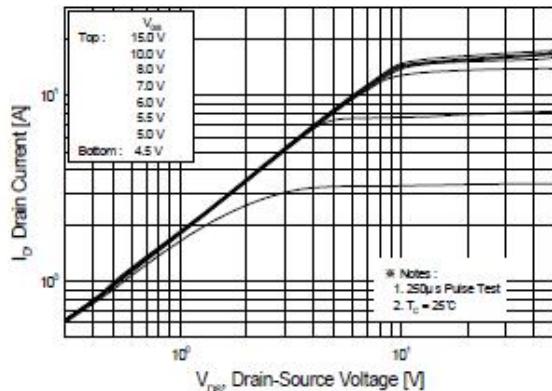
( $T_C=25^\circ\text{C}$ , unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
<b>Off characteristics</b>						
Drain-source breakdown voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	600	-	-	V
Zero gate voltage drain current	$I_{\text{DSS}}$	$V_{\text{DS}}=600\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
		$V_{\text{DS}}=480\text{V}, T_C=125^\circ\text{C}$	-	-	10	$\mu\text{A}$
Gate-body leakage current	Forward	$V_{\text{GS}}=30\text{V}, V_{\text{DS}}=0\text{V}$	-	-	100	nA
	Reverse	$V_{\text{GS}}=-30\text{V}, V_{\text{DS}}=0\text{V}$	-	-	-100	nA
Breakdown voltage temperature coefficient	$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	$I_{\text{D}}=250\mu\text{A}$ , referenced to $25^\circ\text{C}$	-	0.6	-	$\text{V}/^\circ\text{C}$
<b>On characteristics</b>						
Gate threshold voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.0	-	4.0	V
Static drain-source on-resistance	$R_{\text{DS(on)}}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=3.5\text{A}$	-	1.15	1.4	$\Omega$
<b>Dynamic characteristics</b>						
Input capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	-	1020	-	pF
Output capacitance	$C_{\text{oss}}$		-	90	-	pF
Reverse transfer capacitance	$C_{\text{rss}}$		-	10.5	-	pF
<b>Switching characteristics</b>						
Turn-on delay time	$t_{\text{d(on)}}$	$V_{\text{DD}}=300\text{V}, I_{\text{D}}=7\text{A}, R_G=25\Omega$ (note4,5)	-	15	-	ns
Rise time	$t_r$		-	9	-	ns
Turn-off delay time	$t_{\text{d(off)}}$		-	83	-	ns
Fall time	$t_f$		-	21	-	ns
Total gate charge	$Q_g$	$V_{\text{DS}}=480\text{V}, I_{\text{D}}=7\text{A}, V_{\text{GS}}=10\text{V}$ (note4,5)	-	22	-	nC
Gate-source charge	$Q_{\text{gs}}$		-	5	-	nC
Gate-drain charge	$Q_{\text{gd}}$		-	8	-	nC
<b>Drain-source diode characteristics and maximum ratings</b>						
Drain-source diode forward voltage	$V_{\text{SD}}$	$V_{\text{GS}}=0\text{V}, I_{\text{SD}}=7\text{A}$	-	-	1.4	V
Continuous drain-source current	$I_{\text{SD}}$		-	-	7	A
Pulsed drain-source current	$I_{\text{SM}}$		-	-	28	A
Reverse recovery time	$t_{\text{rr}}$	$V_{\text{GS}}=0\text{V}, I_{\text{SD}}=7\text{A}$ $dI_F/dt=100\text{A}/\mu\text{s}$ (note4)	-	405	-	ns
Reverse recovery charge	$Q_{\text{rr}}$		-	3.3	-	$\mu\text{C}$

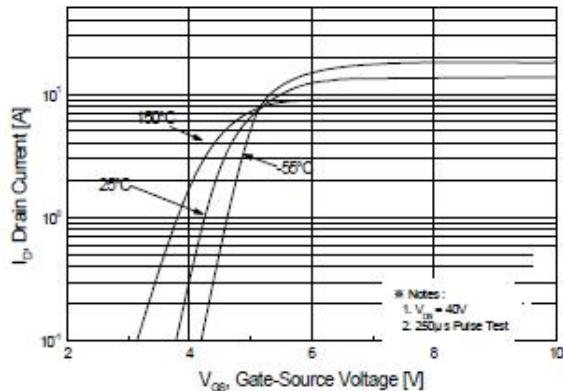
Note:1. Repetitive rating: pulse width limited by maximum junction temperature

2.  $L=9\text{mH}, I_{\text{AS}}=7\text{A}, V_{\text{DD}}=50\text{V}, R_G=25\Omega$ , staring  $T_J=25^\circ\text{C}$
3.  $I_{\text{SD}} \leq 7.0\text{A}, dI/dt \leq 200\text{A}/\mu\text{s}, V_{\text{DD}} \leq \text{BV}_{\text{DSS}}$ , staring  $T_J=25^\circ\text{C}$
4. Pulse test: pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$
5. Essentially independent of operating temperature

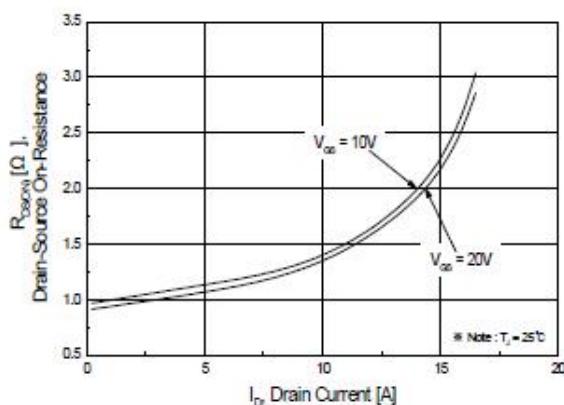
## 7. Test circuits and waveforms



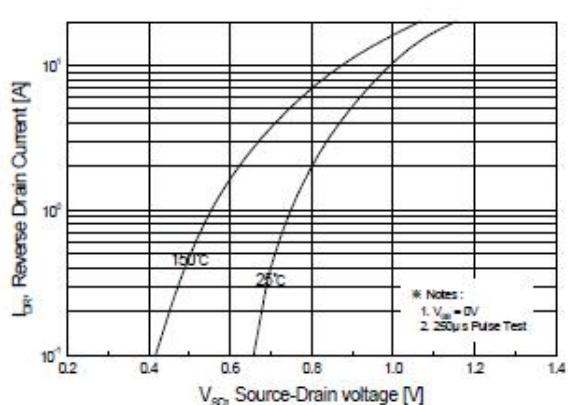
**Figure 1. On-Region Characteristics**



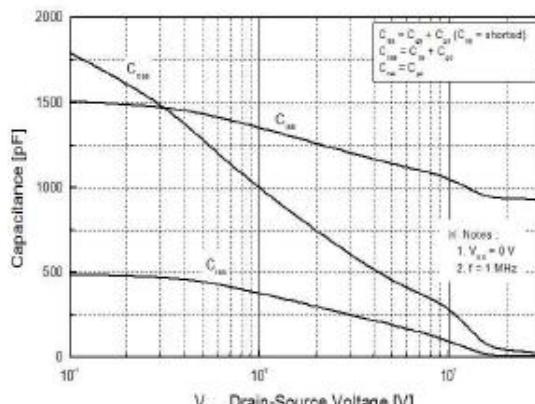
**Figure 2. Transfer Characteristics**



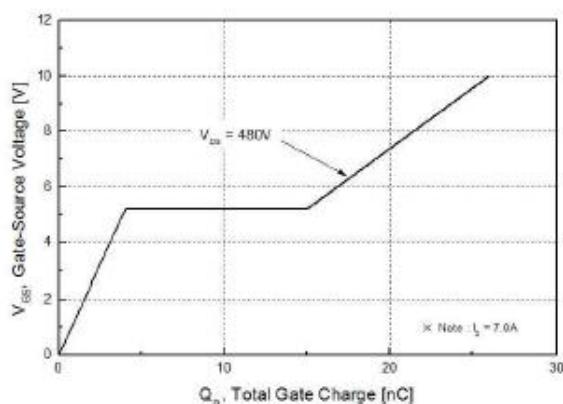
**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**



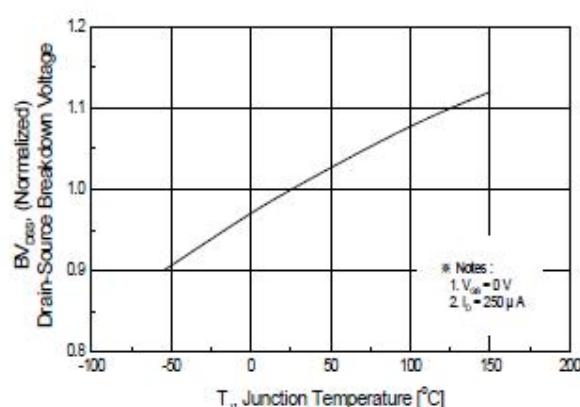
**Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature**



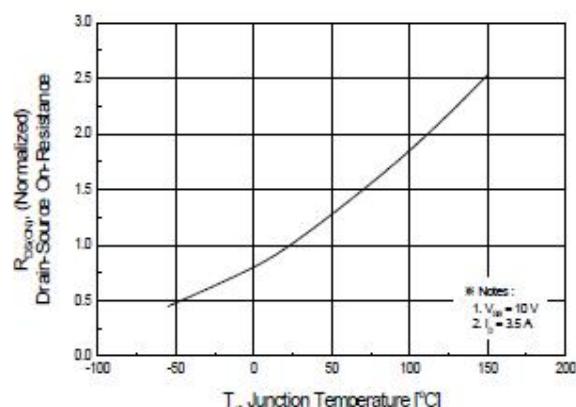
**Figure 5. Capacitance Characteristics**



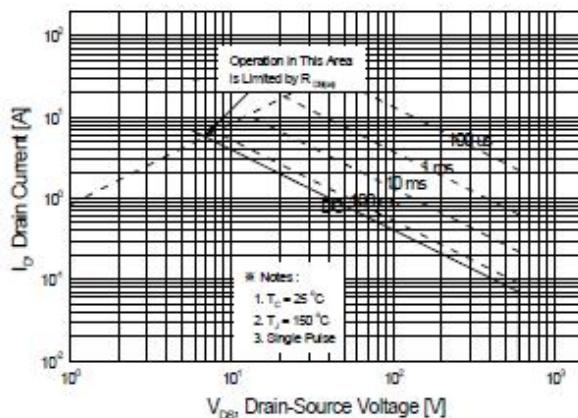
**Figure 6. Gate Charge Characteristics**



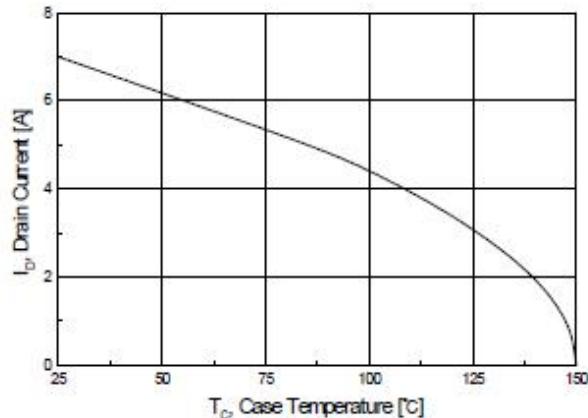
**Figure 7. Breakdown Voltage Variation vs Temperature**



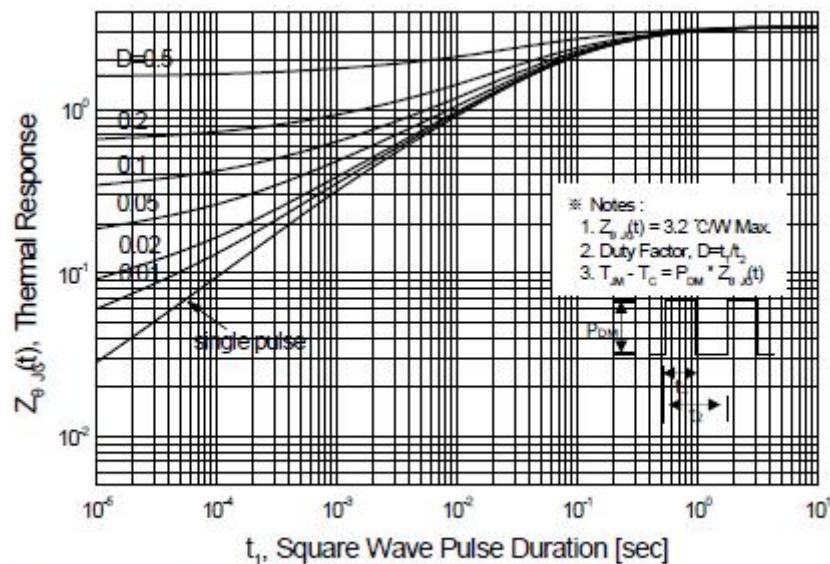
**Figure 8. On-Resistance Variation vs Temperature**



**Figure 9 Maximum Safe Operating Area**

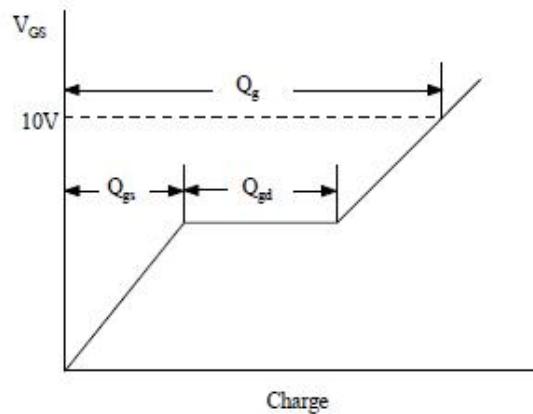
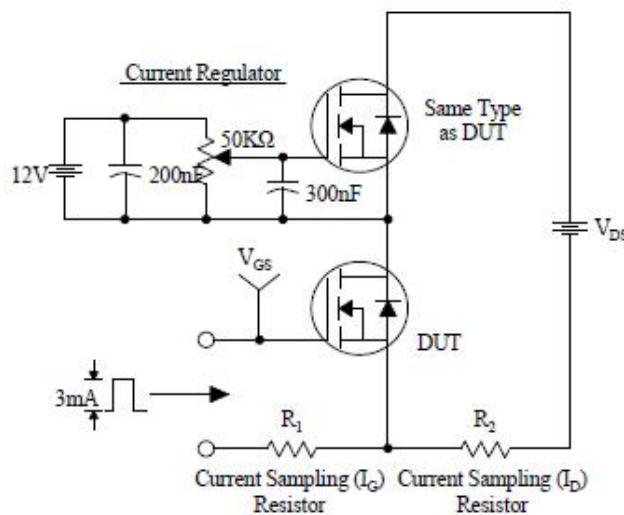


**Figure 10. Maximum Drain Current vs Case Temperature**

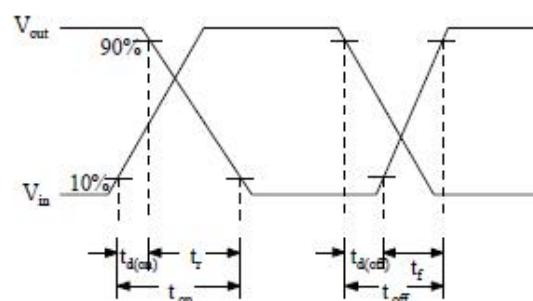
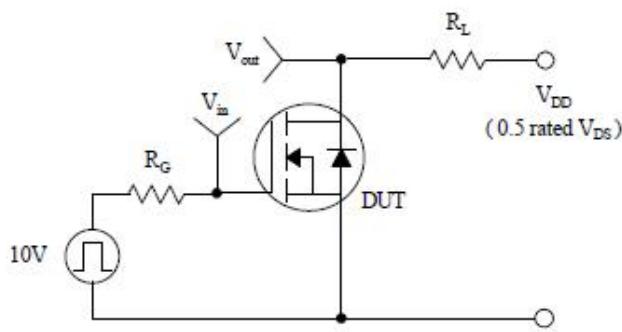


**Figure 11 Transient Thermal Response Curve**

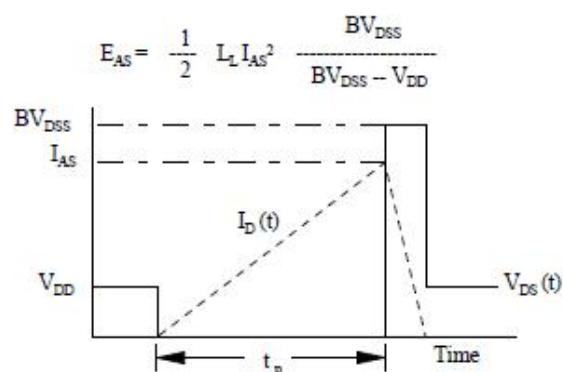
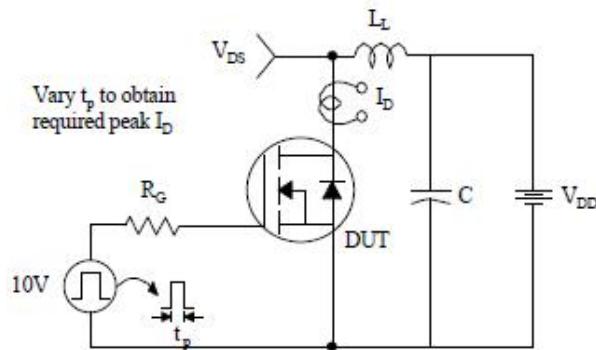
### Gate Charge Test Circuit & Waveform



### Resistive Switching Test Circuit & Waveforms



### Unclamped Inductive Switching Test Circuit & Waveforms



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